

| Notice of References Cited |   |                |                        | Application No.<br><i>09/762,881</i> | Applicant(s)<br><i>Narange et al</i> |                                |
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|                            |   |                |                        | Examiner<br><i>M.L. Padgett</i>      | Group Art Unit<br><i>1762</i>        |                                |
|                            |   |                |                        | Page <i>1</i> of <i>1</i>            |                                      |                                |
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| <i>C</i>                   | <i>4,576,689</i>  | <i>3/1986</i>  | <i>Makkaev et al</i>   | <i>427</i>                           | <i>97</i>                            |                                |
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| <i>P</i>                   |   |                |                        |                                      |                                      |                                |
| <i>Q</i>                   |   |                |                        |                                      |                                      |                                |
| <i>R</i>                   |   |                |                        |                                      |                                      |                                |
| <i>S</i>                   |   |                |                        |                                      |                                      |                                |
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